

1 High-Sensitivity Indirect X-ray Detector Using Ultrasonically Exfoliated MoS₂

2 Monolayer in active layer

3 Chanyeol Lee,^a Jehoon Lee^b, Jaewon Son^a and Jungwon Kang^{*c, d}

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5 ^a Department of Foundry Engineering, Dankook University, Yongin-si 16890, Korea

6 ^b Device Enabling Team, DB HiTek Bucheon-si 14519, Korea

7 ^c Convergence Semiconductor Research Center, Dankook University, Yongin-si 16890, Korea

8 ^d Department of Convergence Semiconductor Engineering, Dankook University, Yongin-si 16890, Korea

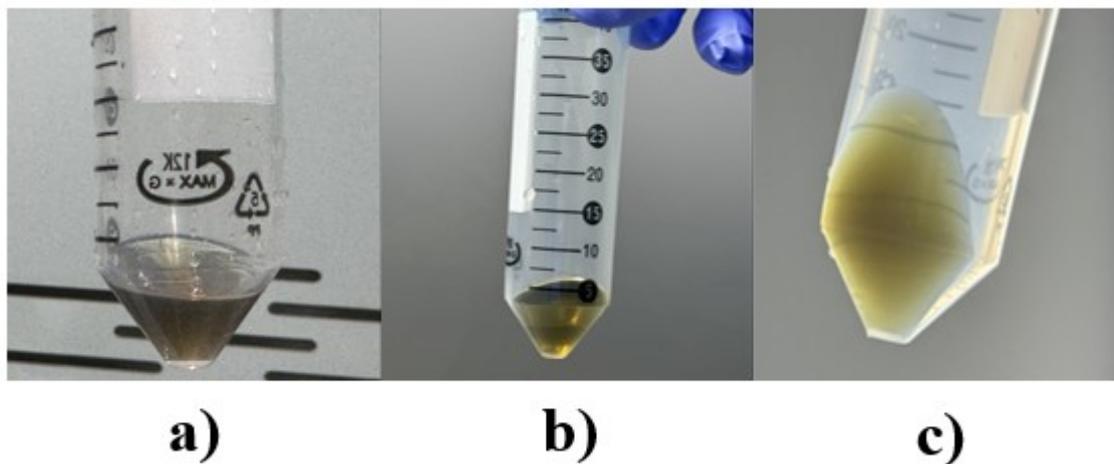
9 *Correspondence: jkang@dankook.ac.kr (J.K.)

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11 1. Images of MoS₂ after exfoliation and centrifugation and developed X-ray detector.

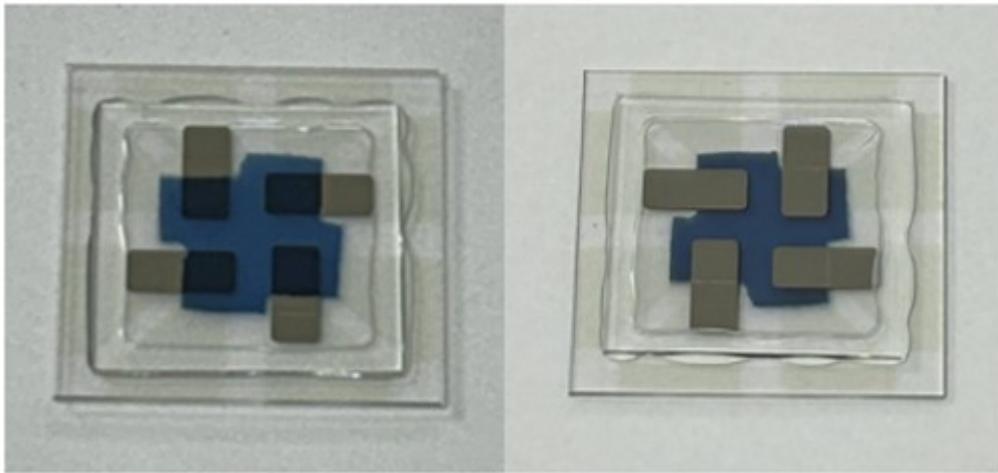
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13 When MoS₂ is dispersed in DMF, the color changes from dark gray to increasingly yellow as the centrifugation speed
14 increases.



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16 Fig. S1 MoS₂ centrifugated by a) 4000 rpm, b) 6000 rpm, c) 8000 rpm after exfoliation.



a)

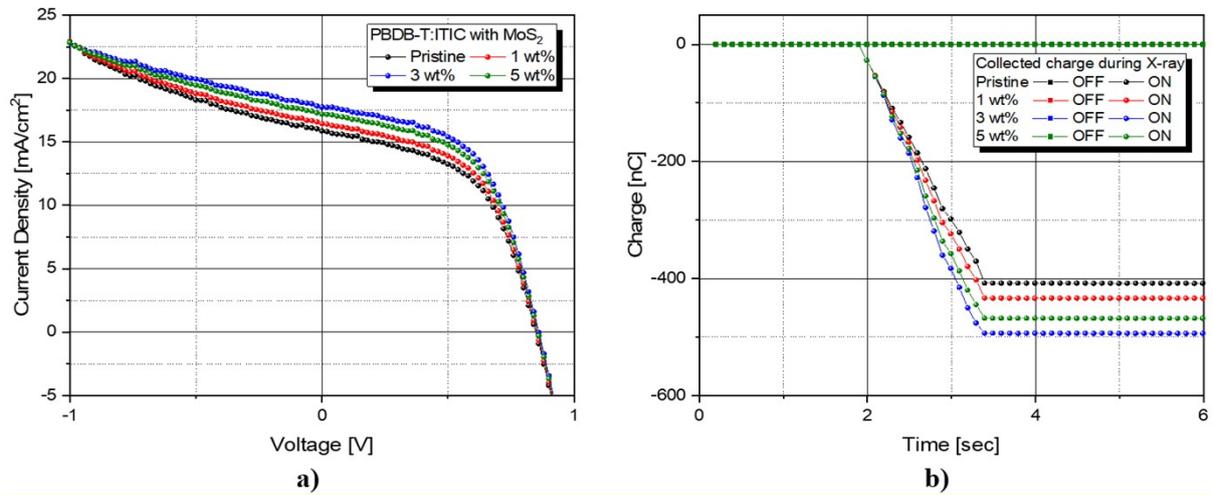
b)

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2 Fig. S2 Images of a) front side and b) back side of developed X-ray detector

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1 **2. Photovoltaic parameters of developed X-ray detector.**



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3 Fig. S3 Photovoltaic parameters of PBDB-T:ITIC devices with different MoS₂ concentrations. a) J-V curve according to different
4 concentration of MoS₂ with solar simulator. b) Collected charge of detectors based on PBDB-T:ITIC active layer with different
5 concentration of MoS₂

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8 Table S1. Photovoltaic parameters and X-ray detecting characteristics among MoS₂ content

Content of MoS ₂	EFF [%]	J _{sc} [mA/cm ²]	V _{oc} [mV]	R _s [Ω]	Sensitivity [mA/Gy·cm ²]	CCD-DCD [μA/cm ²]
Pristine	6.07 ± 0.20	15.86 ± 0.24	847.76 ± 10	489 ± 14	1.440	4.82
1 wt%	6.42 ± 0.16	16.43 ± 0.56	851.32 ± 9	457 ± 11	1.549	5.19
3 wt%	7.13 ± 0.11	17.76 ± 0.26	859.61 ± 12	376 ± 13	1.804	6.04
5 wt%	6.79 ± 0.13	17.21 ± 0.11	856.06 ± 12	421 ± 15	1.702	5.67

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10 Based on the Fig. S3 and Table S1, we determined the MoS₂ content to be 3 wt%. Using 1 wt% MoS₂ would be too low,
11 resulting in minimal effect. Adding 5 wt% MoS₂ would be excessive, potentially affecting the BHJ structure between PBDB-T
12 and ITIC and hindering charge transport.

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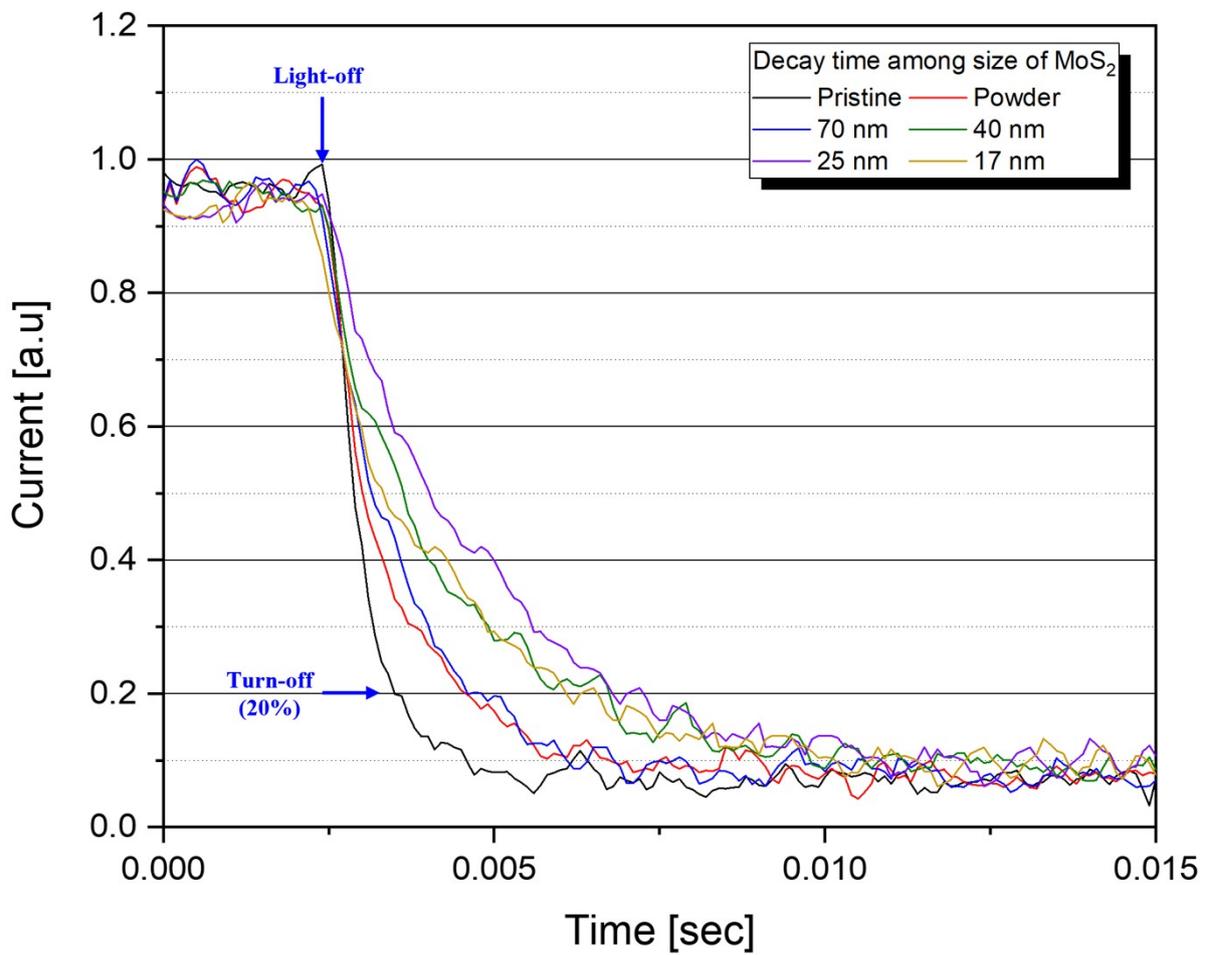
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1 Table S2. Photovoltaic parameters including R_{SH} , FF of developed X-ray detectors

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Size of MoS ₂	EFF [%]	FF [%]	J _{SC} [mA/cm ²]	V _{OC} [mV]	R _S [Ω]	R _{SH} [Ω]
Pure	6.07	51.9	15.86	847.7	489	9154
Bulk MoS ₂	6.53	52.2	16.62	855.9	469	7020
70 nm	6.68	52.6	17.15	848.6	449	9980
40 nm	7.03	52.8	17.53	868.3	415	5540
25 nm	7.13	53.0	17.76	859.6	376	7630
17 nm	6.75	52.9	16.79	858.2	458	8053

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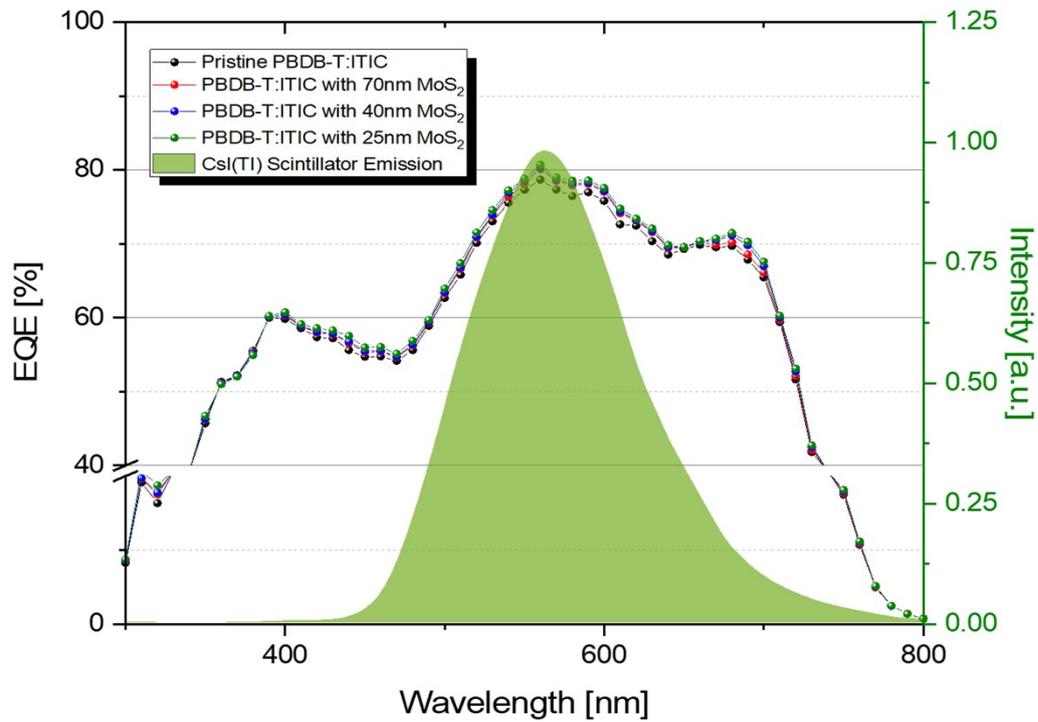
5 Fig. S4 Decay time among size of MoS₂ for extracting effective carrier lifetime

6 Considering the dark current, the turn-off point is defined as the point where the device current reaches 20%. The decay
 7 times for pristine, powder, 70 nm, 40 nm, 25 nm, and 17 nm devices are 0.0035, 0.0046, 0.0049, 0.0066, 0.0073, and 0.0068
 8 seconds, respectively. These decay times are similar to the carrier lifetimes calculated using the Langevin recombination
 9 model, with the device with 25 nm MoS₂ exhibiting the highest performance.

1 Table S3. Thickness deviation of PBDB-T:ITIC active layer among MoS₂ size

Size of MoS ₂	Pristine	70 nm	40 nm	25 nm	17 nm
Thickness [nm]	95±2	103±4	101±3	97±2	96±2

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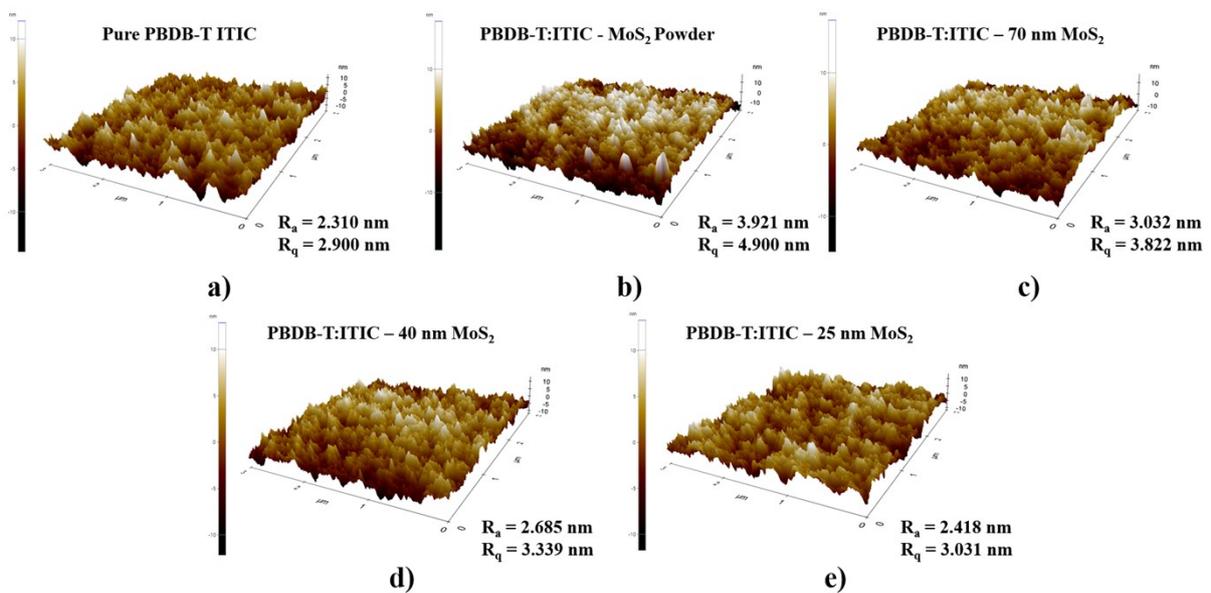
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4 Fig. S5 EQE of PBDB-T:ITIC devices with different size of MoS₂

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6 3. AFM images of active layer of X-ray detector

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9 Fig. S6 AFM images of a) Pure PBDB-T:ITIC and PBDB-T:ITIC with b) powder, c) 70 nm, d) 40 nm, e) 25 nm size of MoS₂